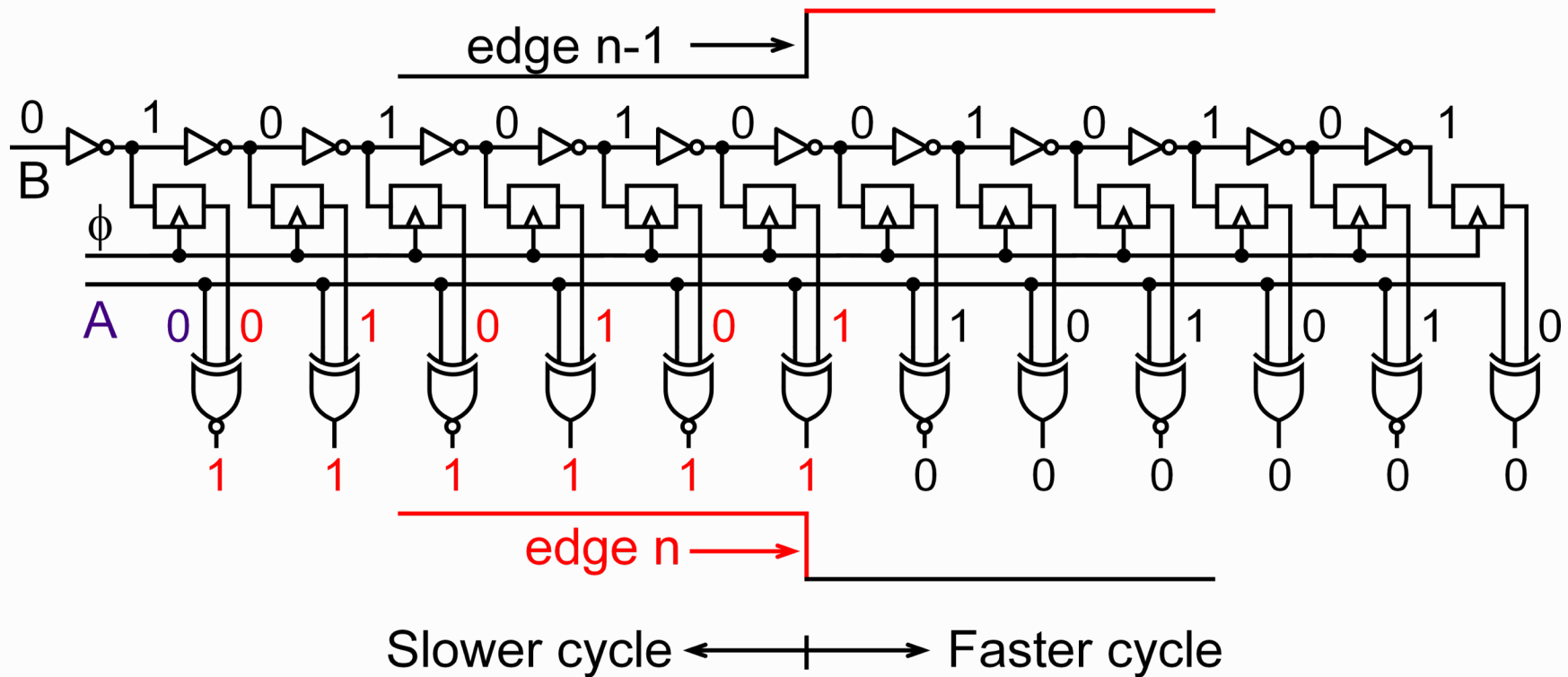


Variation Characterization

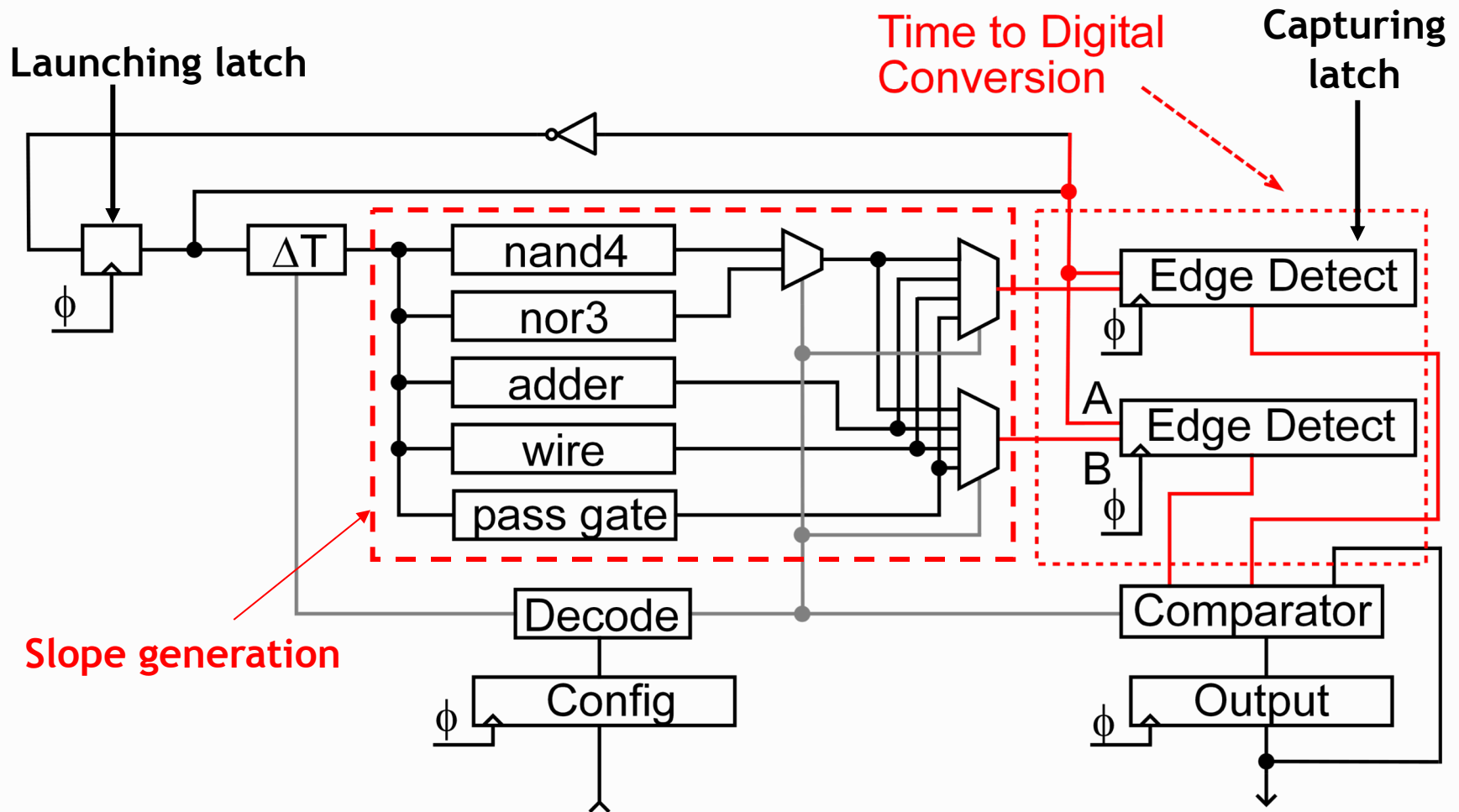
Rahul Rao

IBM Systems and Technology Group

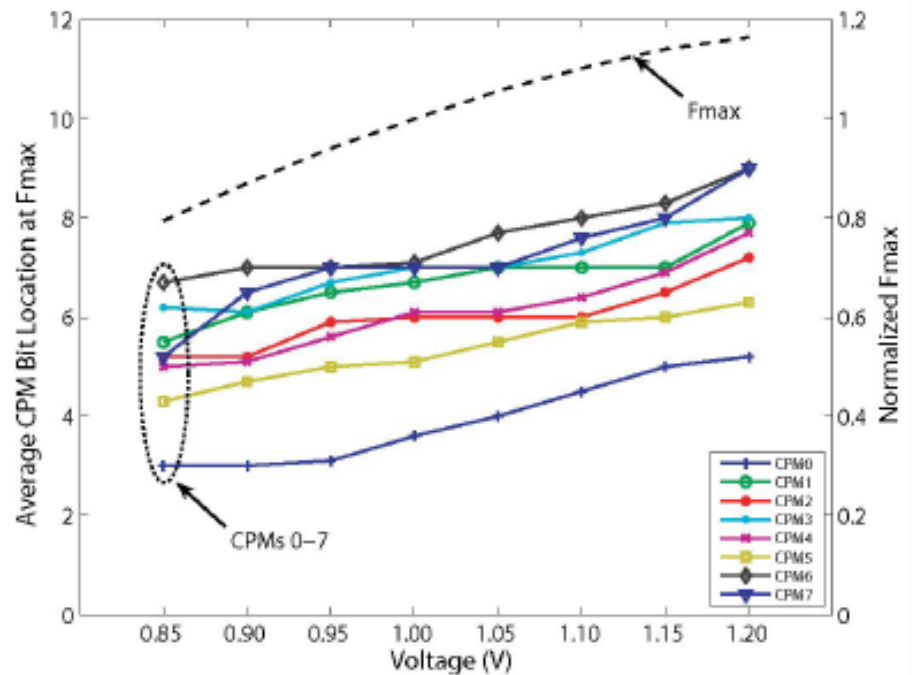
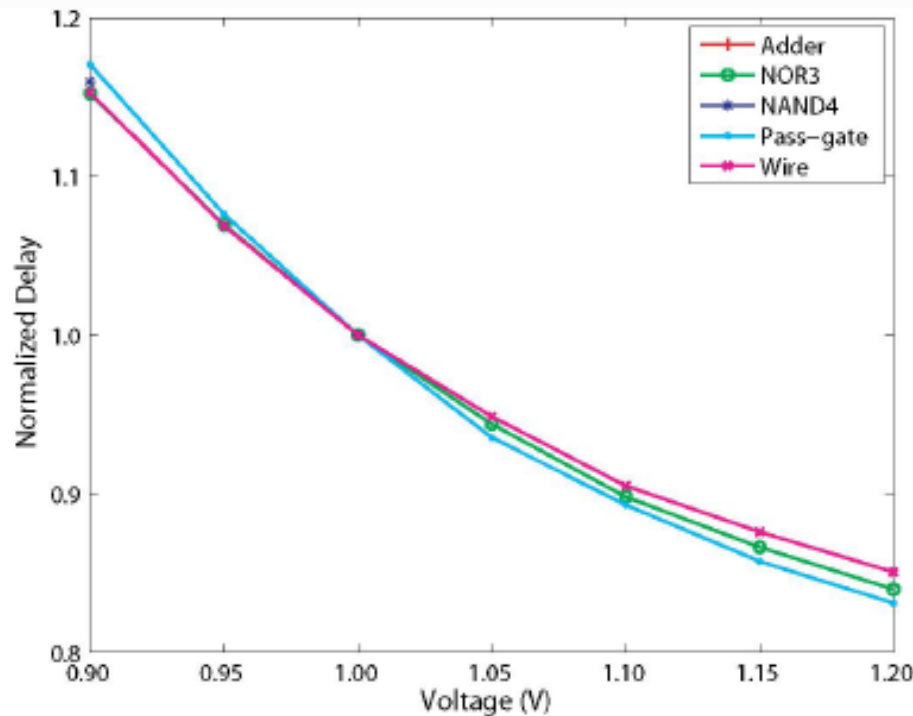
Time-to-Digital Conversion Using an Edge Detector



Delay based Sensing - Critical Path Monitor (CPM)



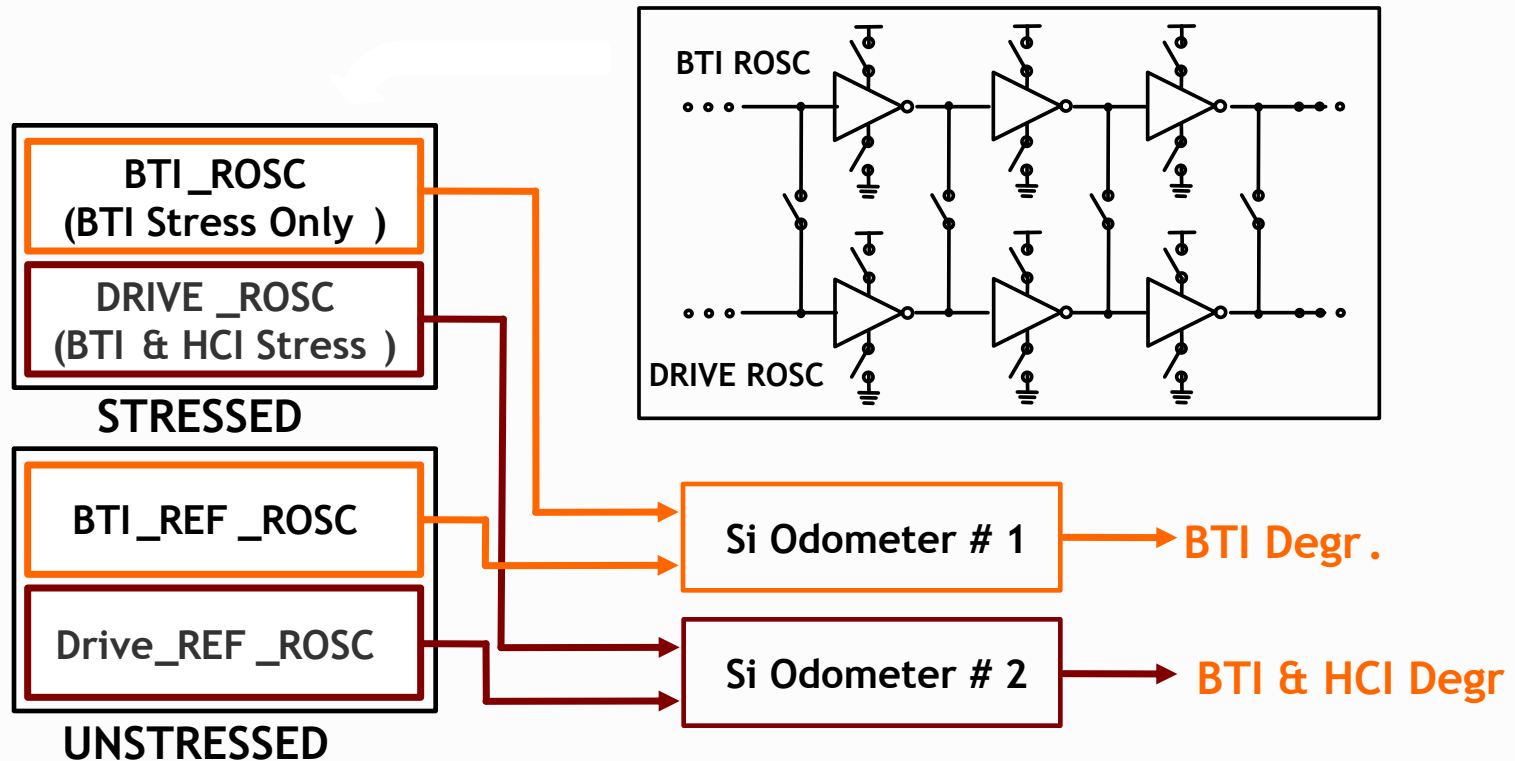
Delay based Sensing - Critical Path Monitor (CPM)



Characterizing Bias Temperature Instability

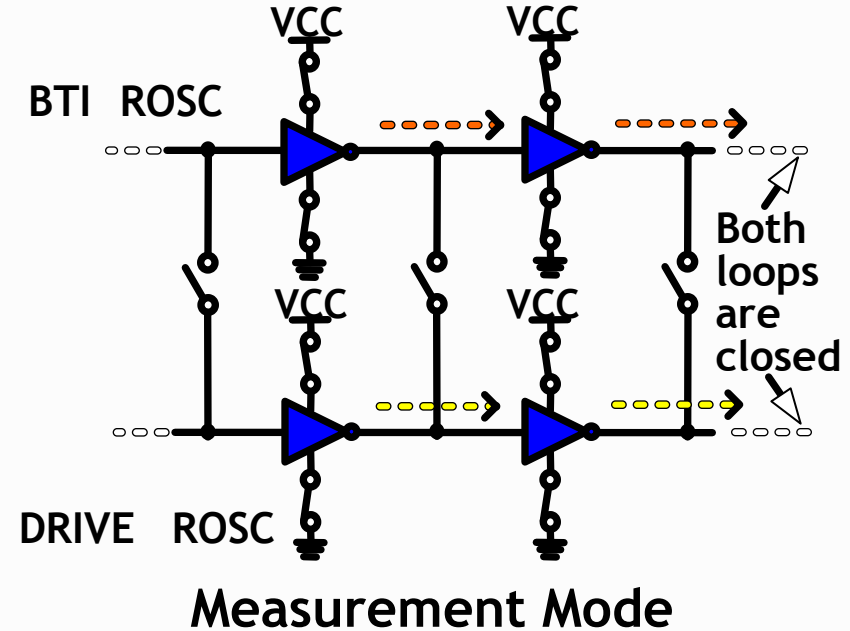
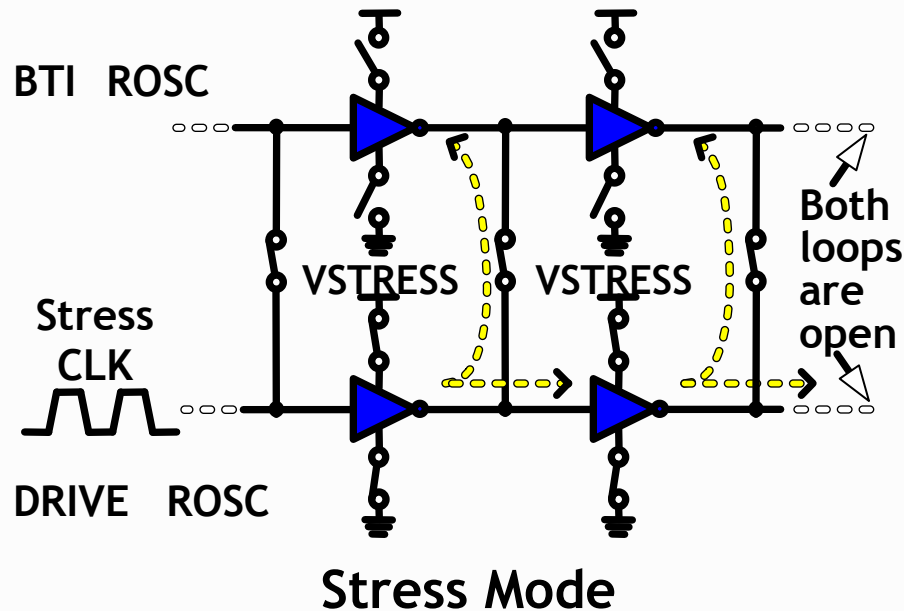
- Challenge
 - Characterize the extent of V_{TH} shift due to aging
 - Isolate the contributions of NBTI vs. PBTI while minimizing noise due to other effects (hot carrier effects, device breakdown)
 - Rapid post-stress measurement (or during stress measurement) to prevent recovery
- Methods
 - I-V measurement of devices using stress pulses
 - Delay (Oscillator Frequency) based measurement

All-in-One Silicon Odometer



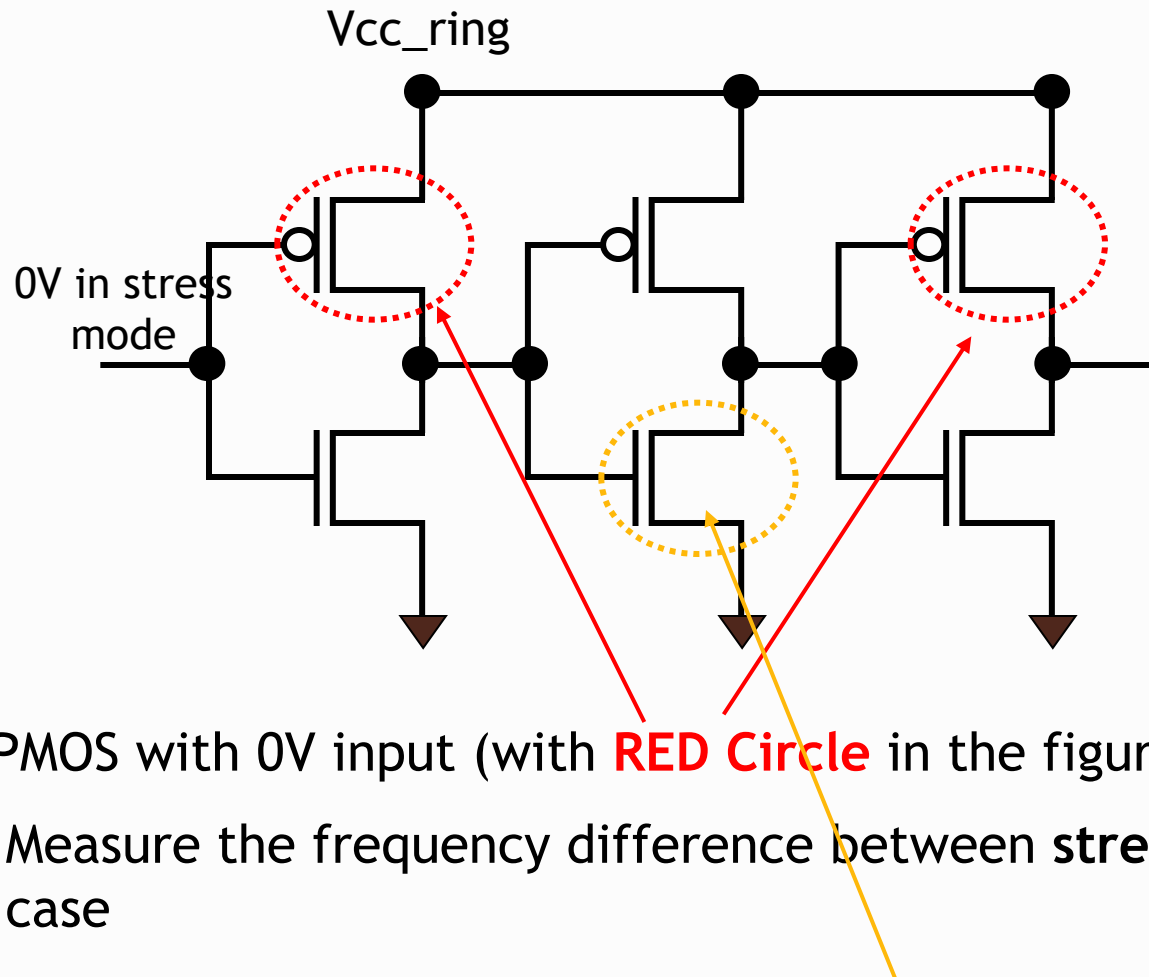
- Isolates BTI, HCI and TDDDB effects
- 4 ROSCs : 2 stressed, and 2 unstressed
 - BTI_ROSC degrades due to BTI only; “DRIVE” ROSC ages due to BTI & HCI
- Frequency degradation measured with beat frequency detection circuits

BackDrive Configuration



- Stress Mode (ROSC loops opened)
 - BTI_ROSC gated off, DRIVE_ROSC drives transitions; I/P driven by VCO
- Measurement Mode (ROSC loops closed)
 - Both ROSCs connected to the power supply @ VCC, switches between them are opened

Ring Oscillator Based Circuit



In Stress Mode:

V_{cc_ring} and/or temperature are raised.
Primary input = 0

In Measurement Mode:

V_{cc_ring} and/or temperature brought back to normal condition

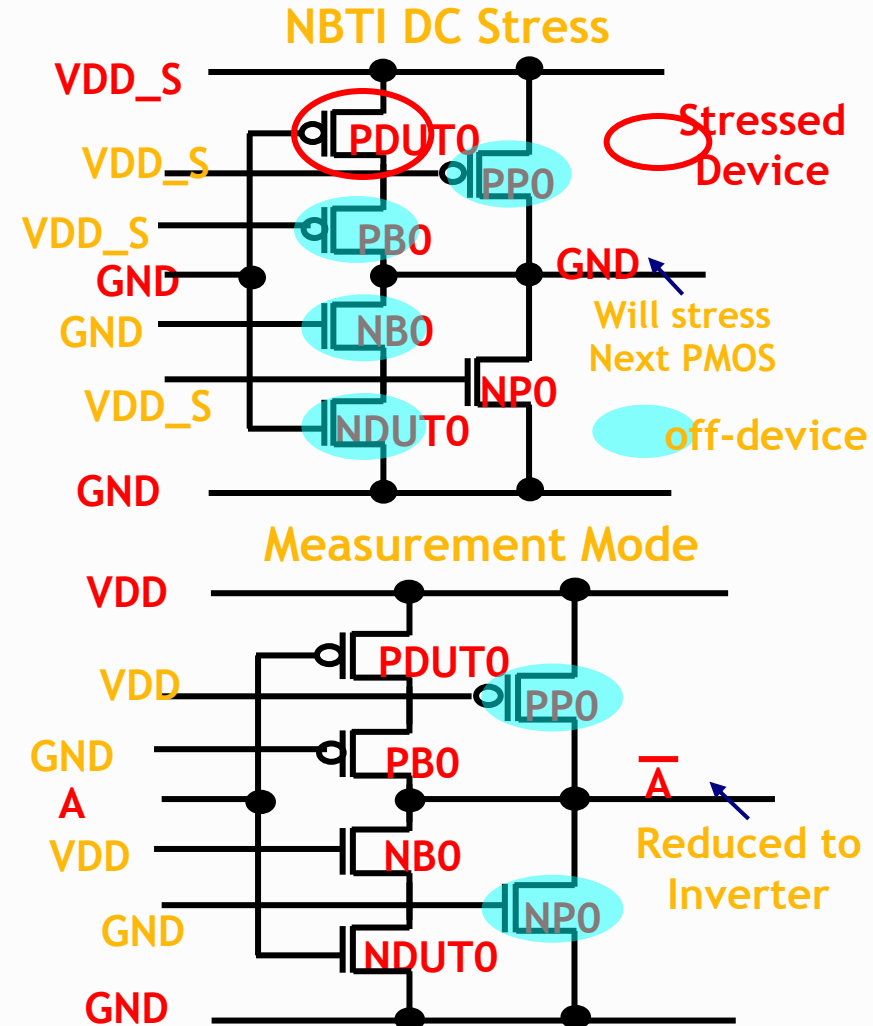
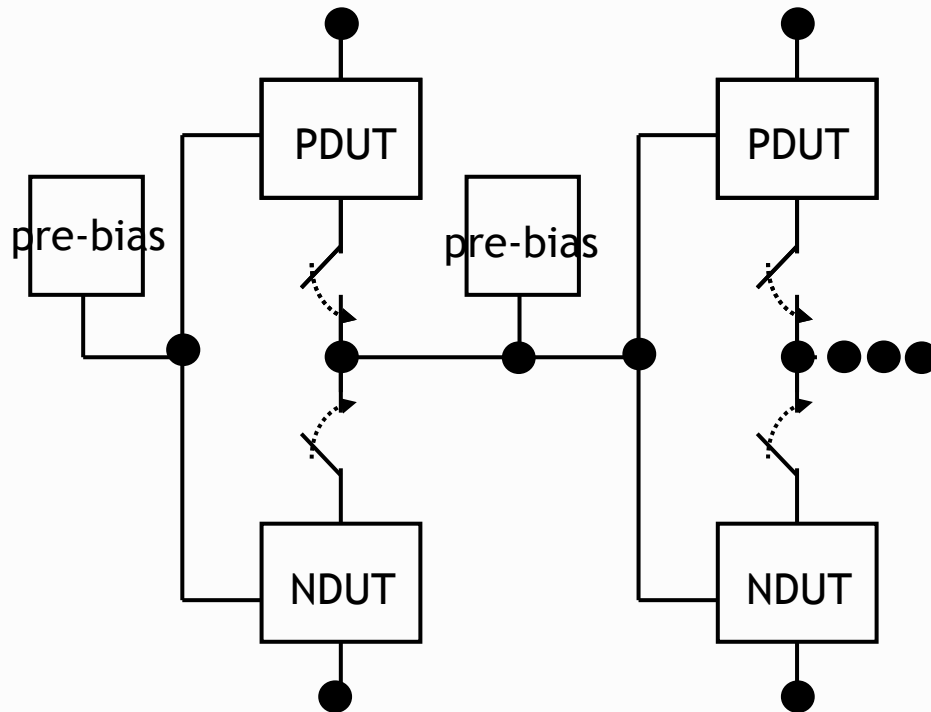
PMOS with 0V input (with **RED Circle** in the figure) is stressed.

Measure the frequency difference between **stressed** case and **unstressed** case

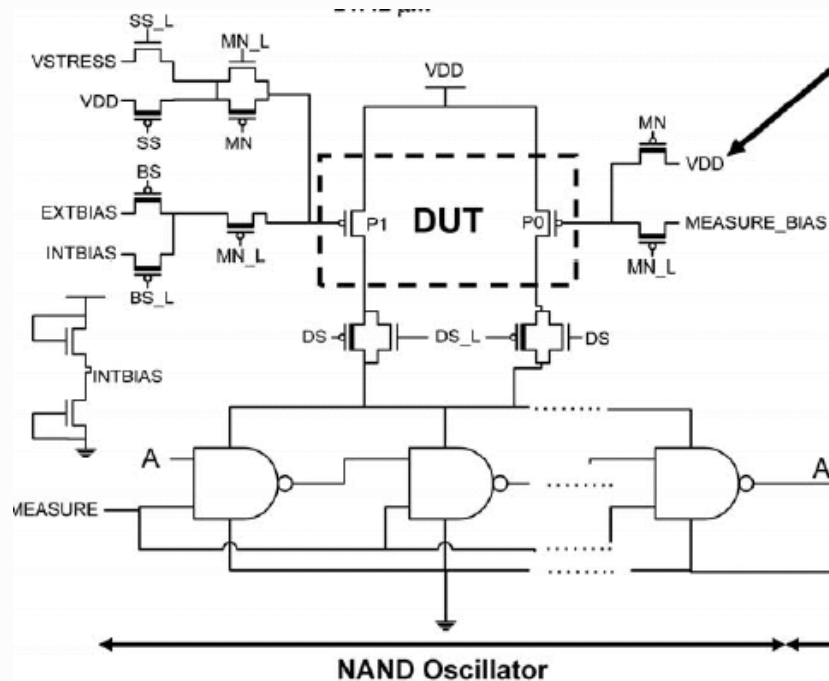
Impossible to isolate the effect from each of NBTI and PBTI

Unified NBTI - PBTI Sensor

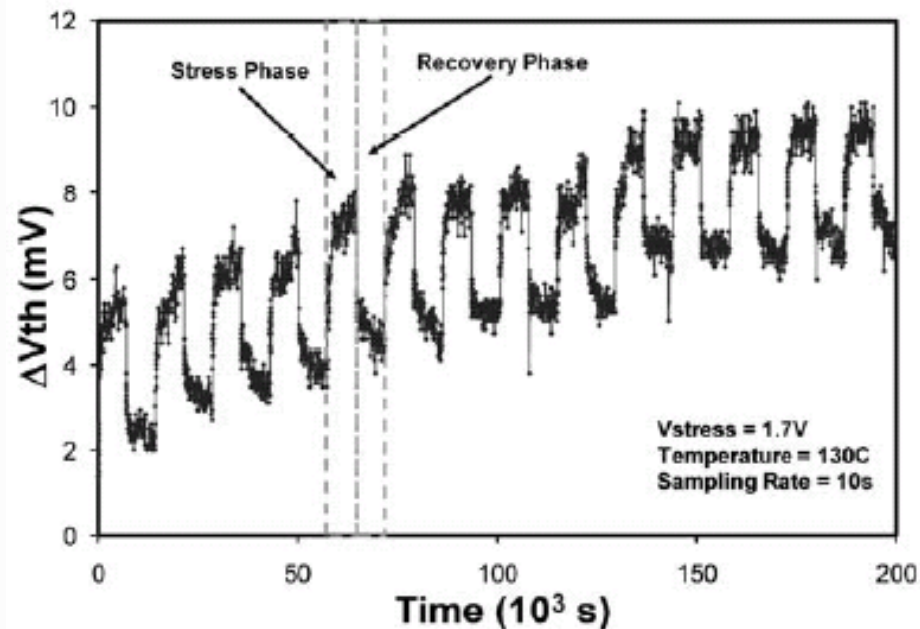
Objective: Maintain the simplicity of RSC style monitoring circuit, while isolating NBTI and PBTI



Sub-Threshold BTI Sensor



PMOS Device Biased in sub-threshold region controls current to a Oscillator

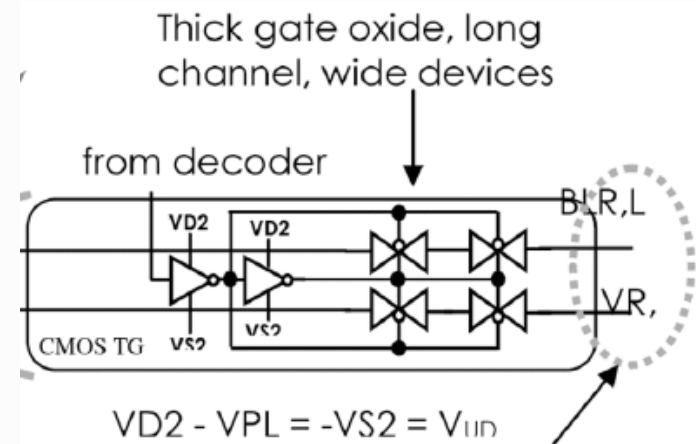
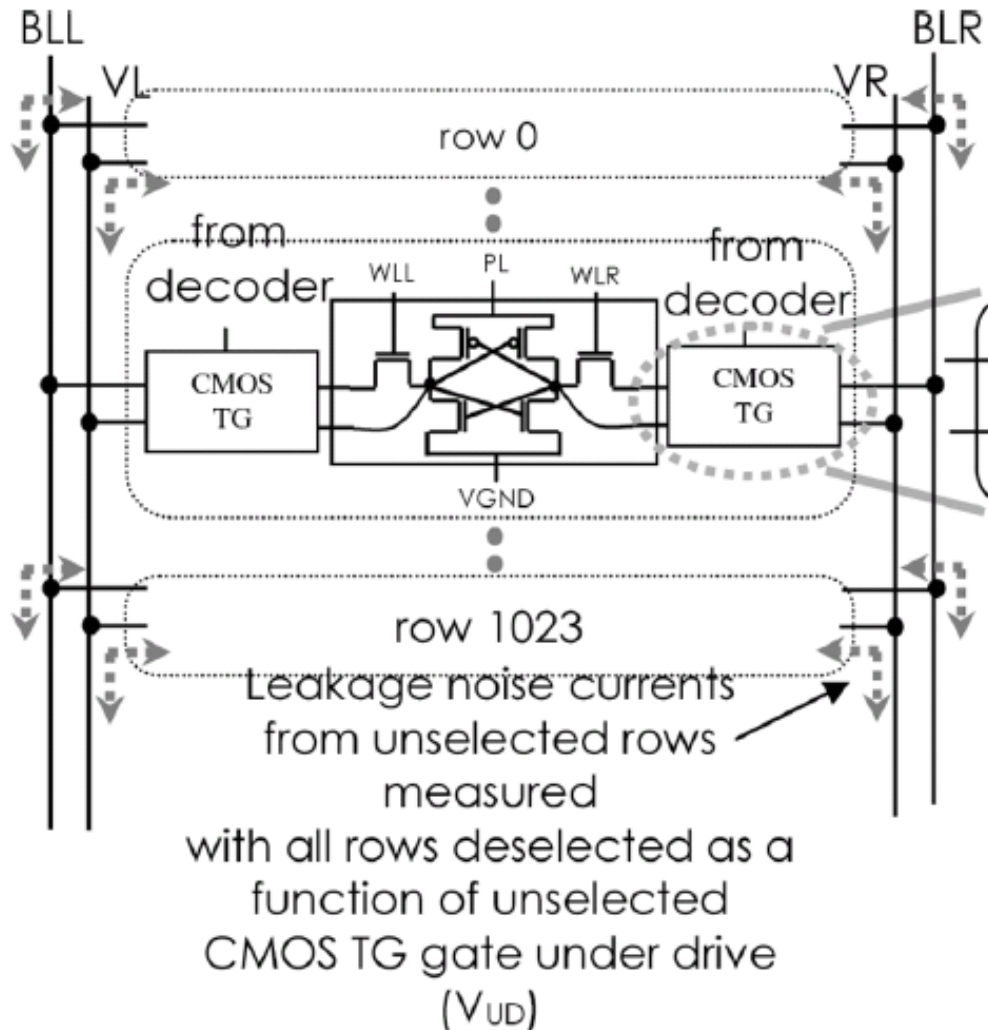


Measured threshold voltage shift during Stress and Recovery

Can we directly characterize more complex circuit properties ?

- Read and Write margin of SRAM
 - Depends on both local variation and global variations
 - Individual device characterization can help but direct characterization of read/write margin can provide better information
- Temperature
 - Using Delay
 - Using Leakage
- Power

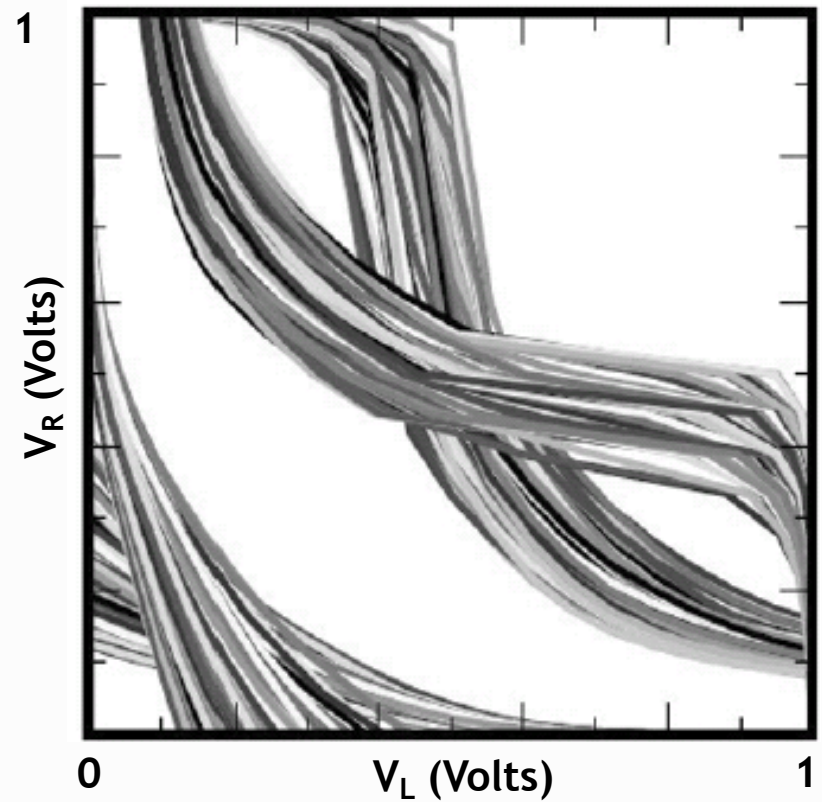
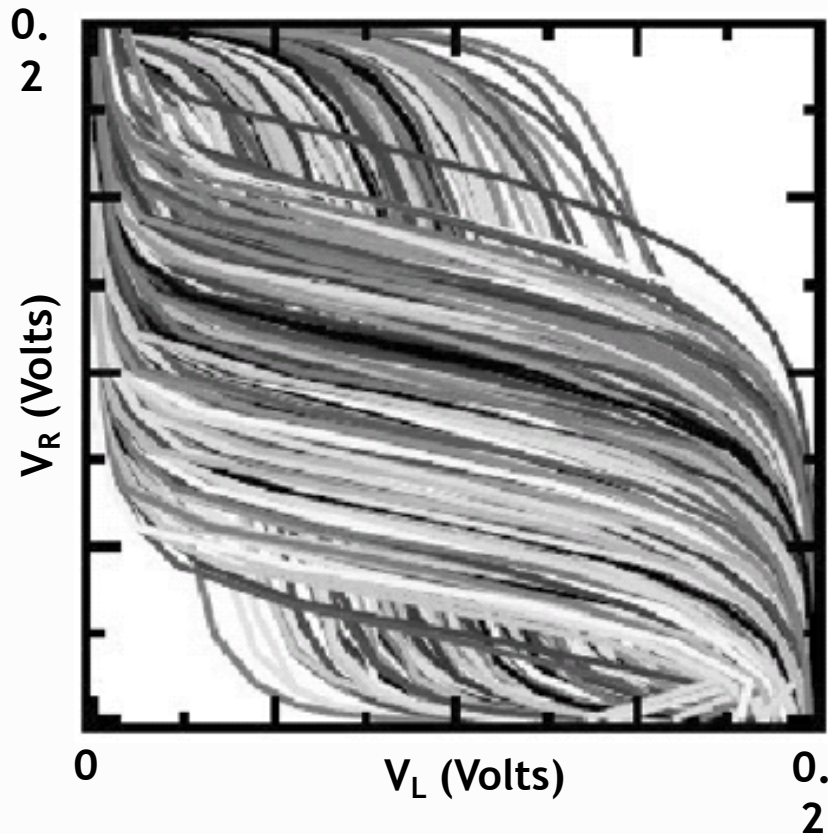
SRAM Fluctuation Monitor



For unselected cells, under-drive pass gates to reduce leakage noise

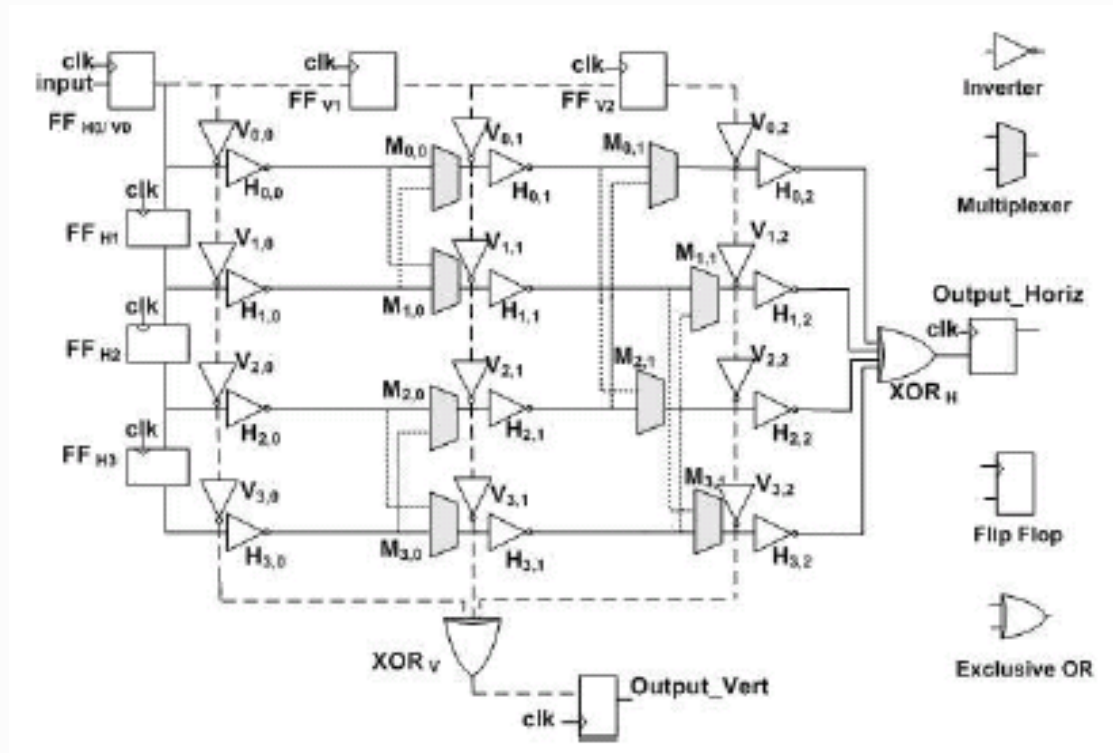
For selected cell, overdrive pass gate to minimize ON resistance

SRAM Fluctuation Monitor



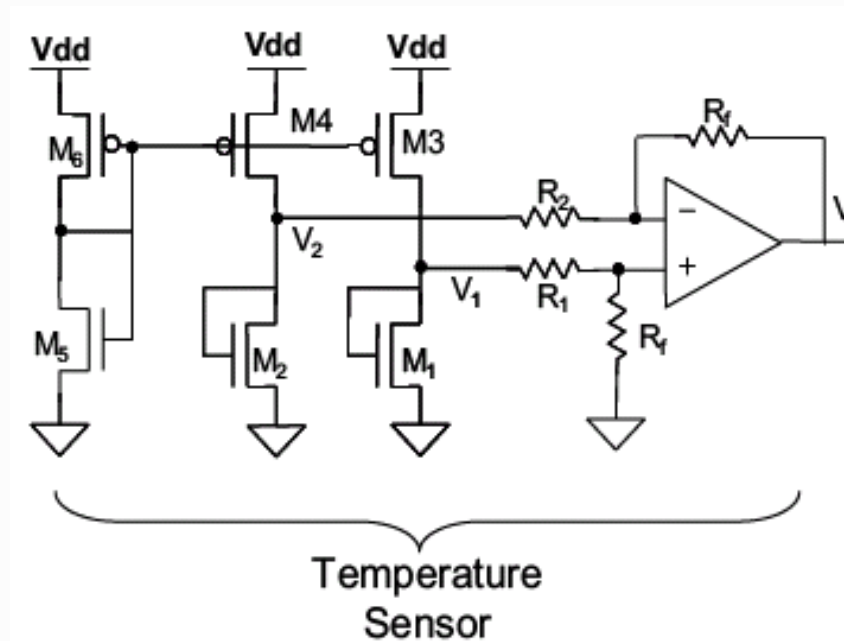
Voltage Transfer Characteristics (measured) for 1k cells for different supply voltages

Sensing Temperature Through Delay



- Delay increases with Temperature
 - Matrix structure of gates with multiplexers that enable activation of any path (using scan-chain controls)
 - Adjust clock frequency to detect path-delay (temperature)

Sensing Temperature Through Leakage



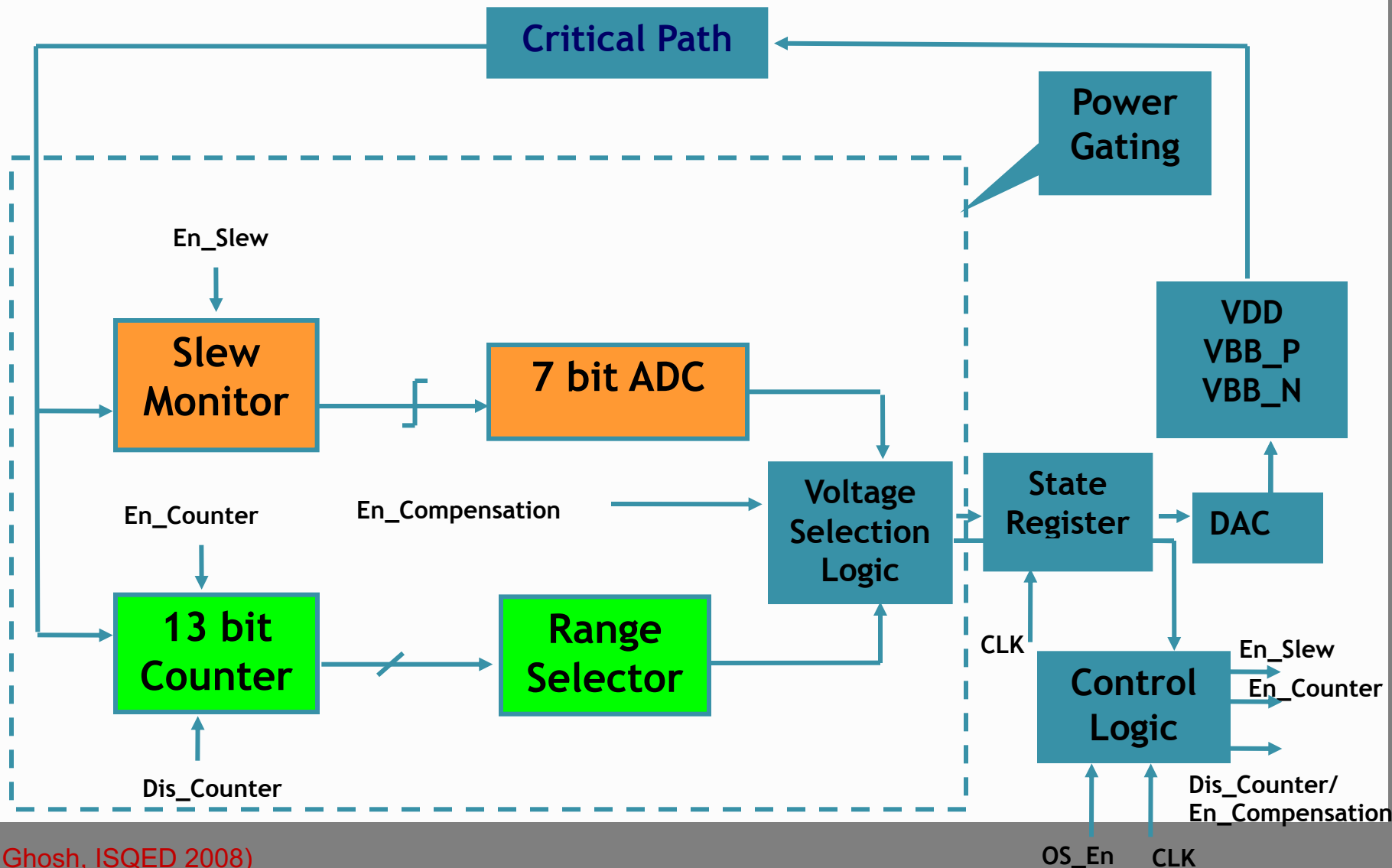
Leakage is exponential function of temperature
(Make devices large to eliminate RDF, LER effects)

Voltage effects cancelled out

$$V_{out} = \frac{R_f}{R_1} \sqrt[\alpha]{\frac{L}{\mu C_{ox}}} \left(\sqrt[\alpha]{\frac{I_1}{W_1}} - \sqrt[\alpha]{\frac{I_2}{W_2}} \right)$$

Variation Adaptation

Block diagram of Detection and Compensation System



Adaptive Body-biasing Based on Delay and Rise/Fall Slew Difference

		$\Delta t_{R-F} > \Delta t_{R-Fnom}$	$\Delta t_{R-F} = \Delta t_{R-Fnom}$	$\Delta t_{R-F} < \Delta t_{R-Fnom}$
$f > f_{nom}$	NMOS	LRBB	RBB	SRBB
	PMOS	SRBB	RBB	LRBB
$f = f_{nom}$	NMOS	RBB	No bias	FBB
	PMOS	FBB	No bias	RBB
$f < f_{nom}$	NMOS	SFBB	FBB	LFBB
	PMOS	LFBB	FBB	SFBB

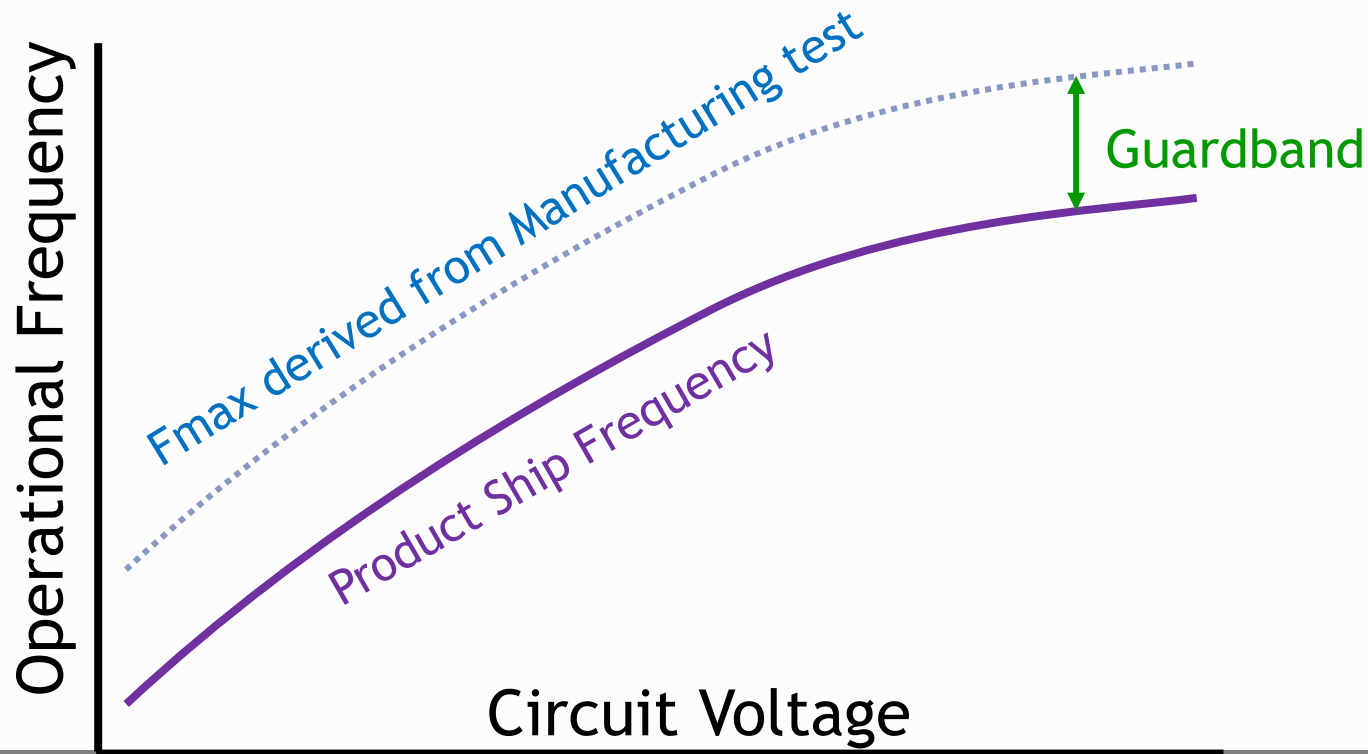


↑ RBB
FBB
↓

- RBB is effective to reduce leakage
- FBB is effective to improve operating frequency of a design in active mode
- PMOS & NMOS need independent body biasing

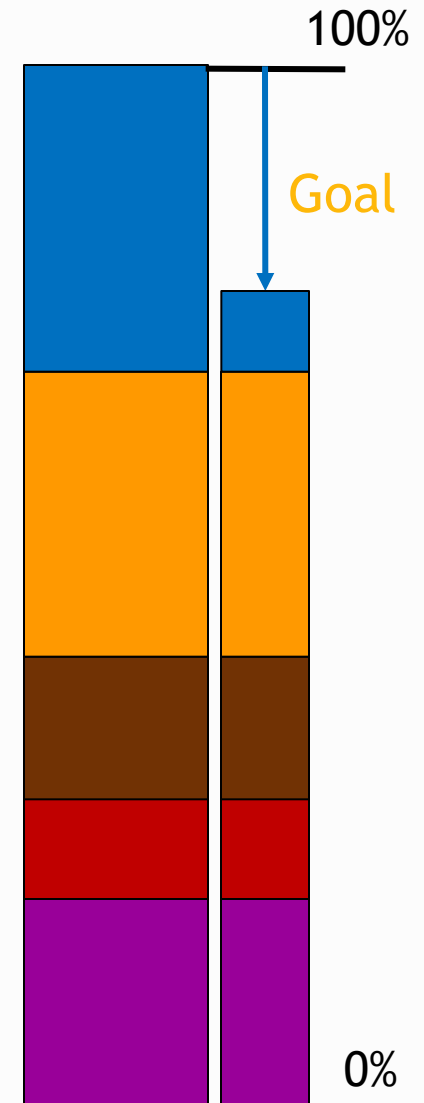
Guard bands

- Designs must account for changes over time:
 - permanent physical degradation
 - temporary operational transients



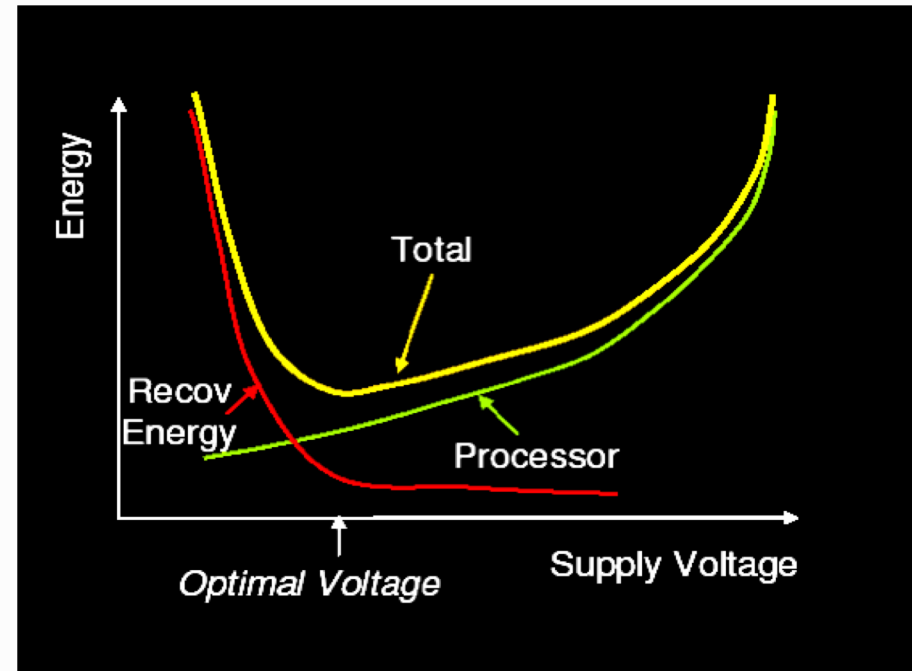
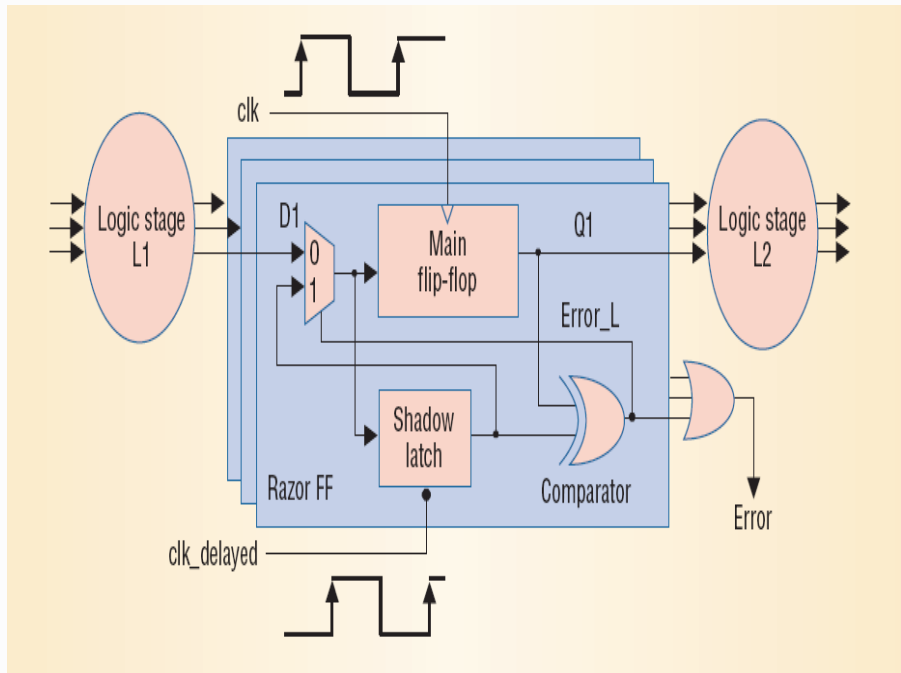
Typical guardband components

- Voltage variation
power supply & system load-line
inaccuracy, droop & noise
- Thermal variation
environment & workload
- Wear out
lifetime degradation
- Manufacturing Test Inaccuracy
correlation error
- Uncertainty
margin for the “unknown”



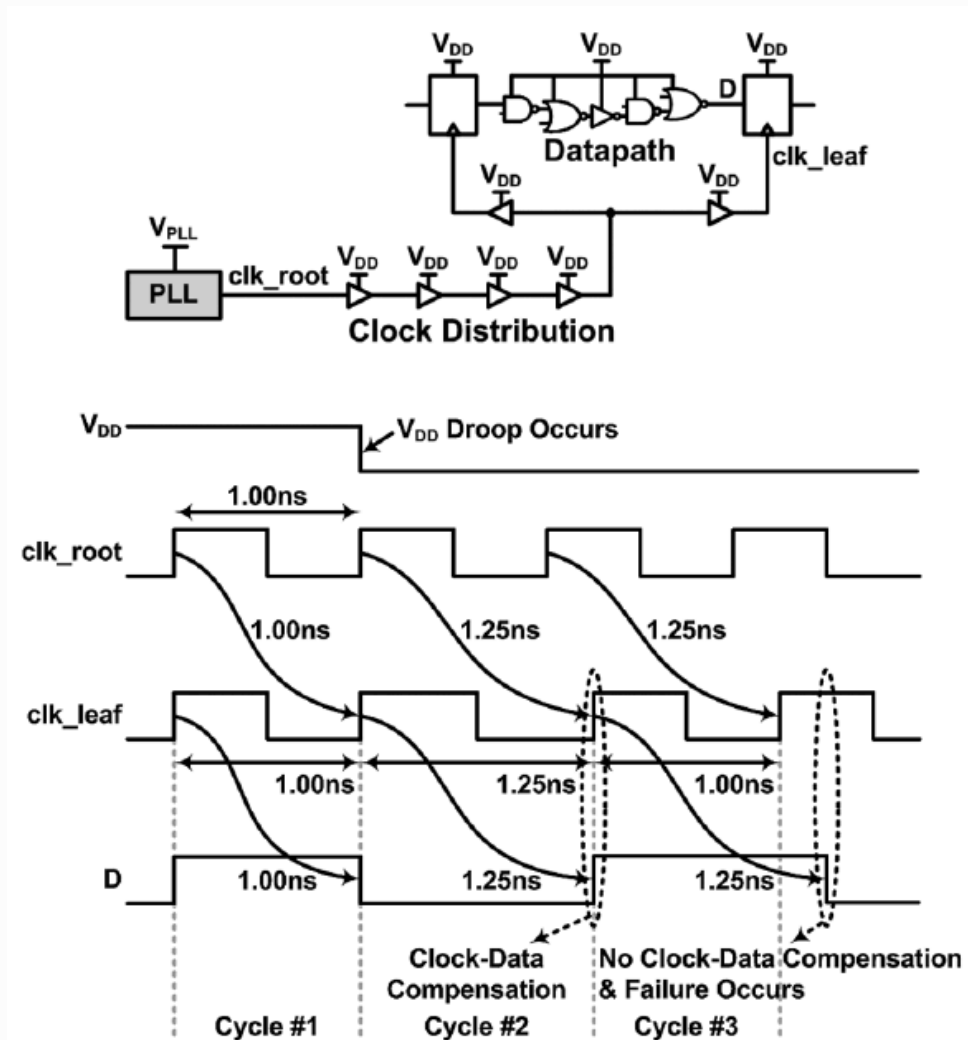
Razor CMOS

- Shadow latch with delayed clock used to detect and recover setup time violation at high-frequency or low-voltage
- Tune voltage by monitoring error rate to remove voltage margin
- 64b processor implementing subset of Alpha instruction set in 0.18 μm CMOS
 - ⊙ Eliminate V_{DD} safety margin, allowing V_{DD} to be scaled 120 mV below 1st failure point
 - ⊙ 44% energy saving over W.C. conditions @ 0.1% target error rate & 120 MHz

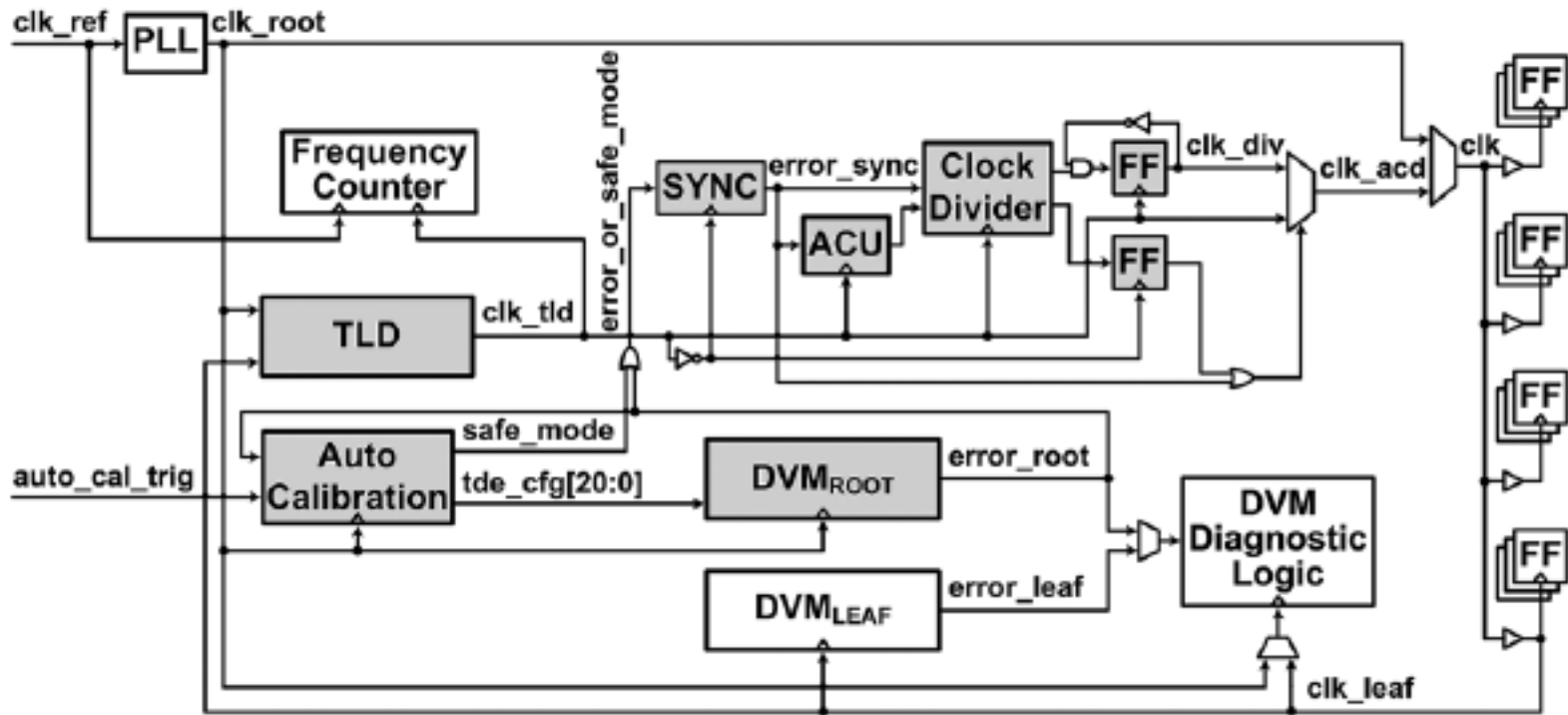


Clock Data Compensation

- Auto Compensation for Cycle 2
- No compensation for Cycle 3

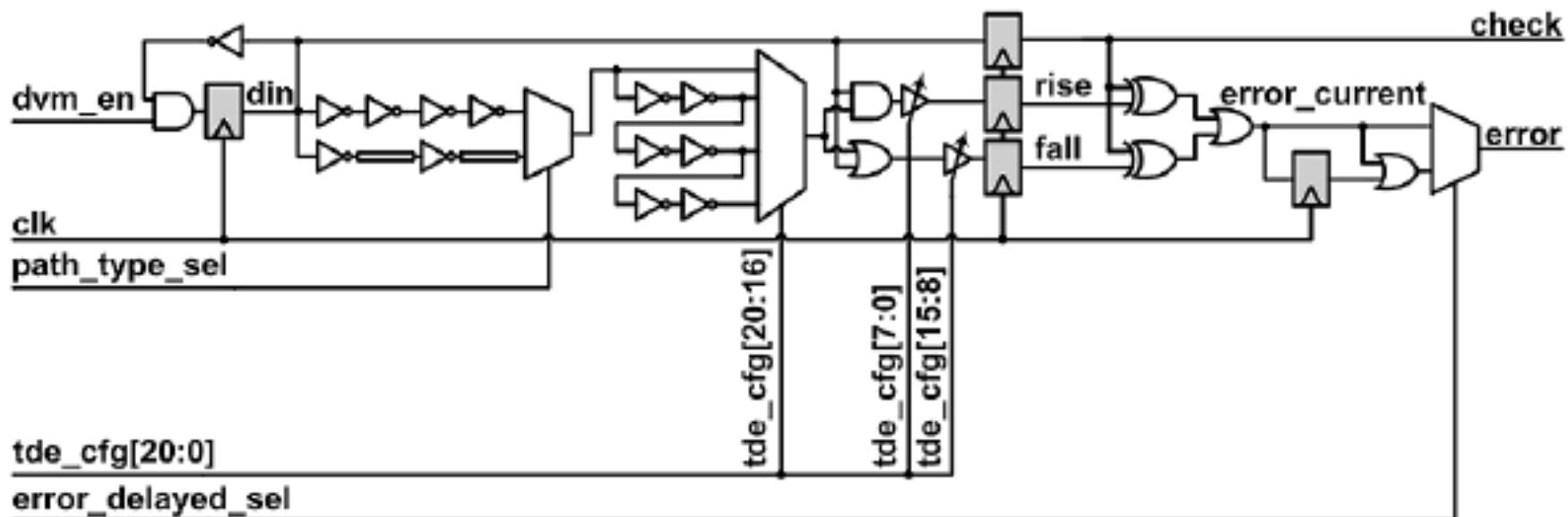


Dynamic Voltage Monitor



- TLD: Determines delay added to clk in case of 'error' detection
- DVM_root: Detection at the source of the tree
- DVM_leaf: Detection at the sink of the tree (@ the latches)

Dynamic Voltage Monitor

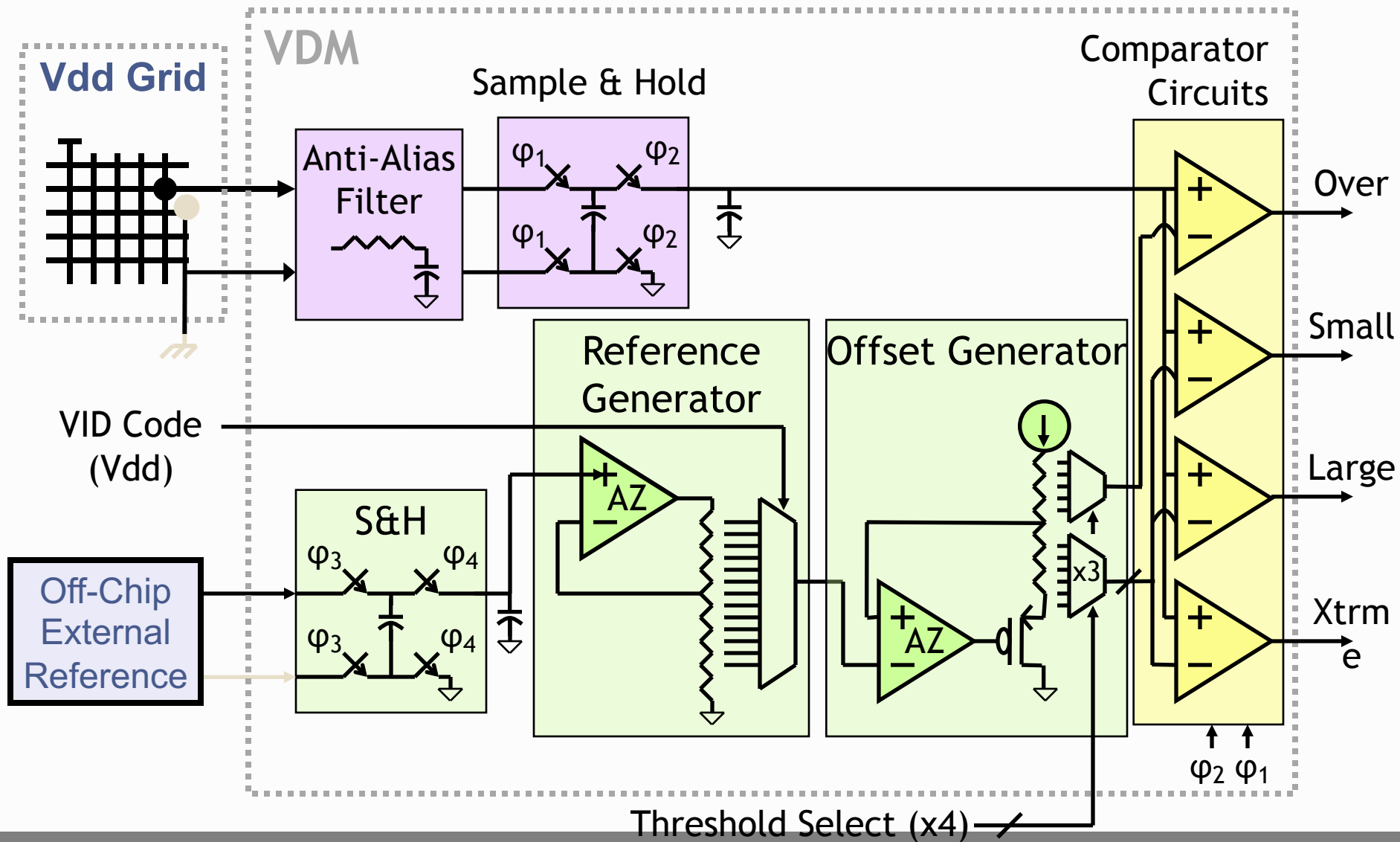


- Alternate cycles measure rise and fall transitions
- Can use path selection (similar to CPM)

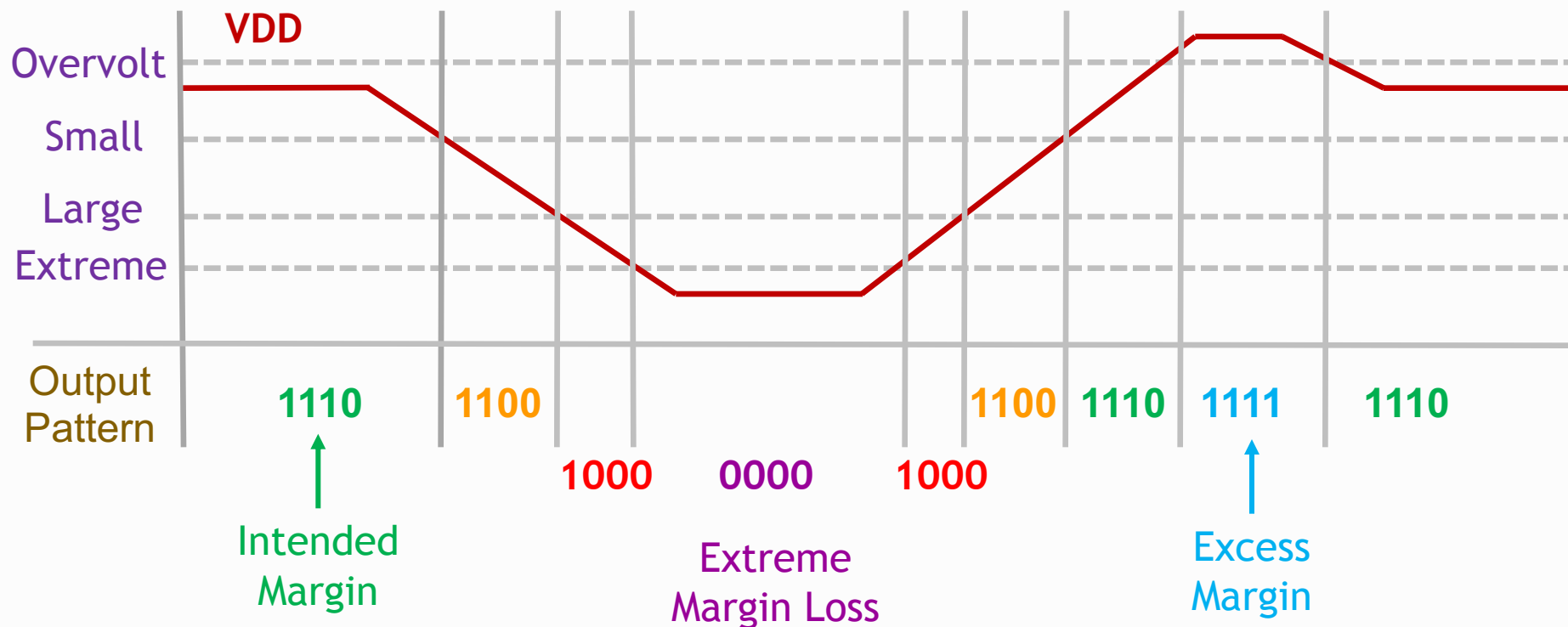
Adaptive Clock Solution

1. Detect voltage droop
2. Respond with immediate action
3. Recover quickly after droop subsides

Voltage Droop Monitor (VDM)



VDM Behavior

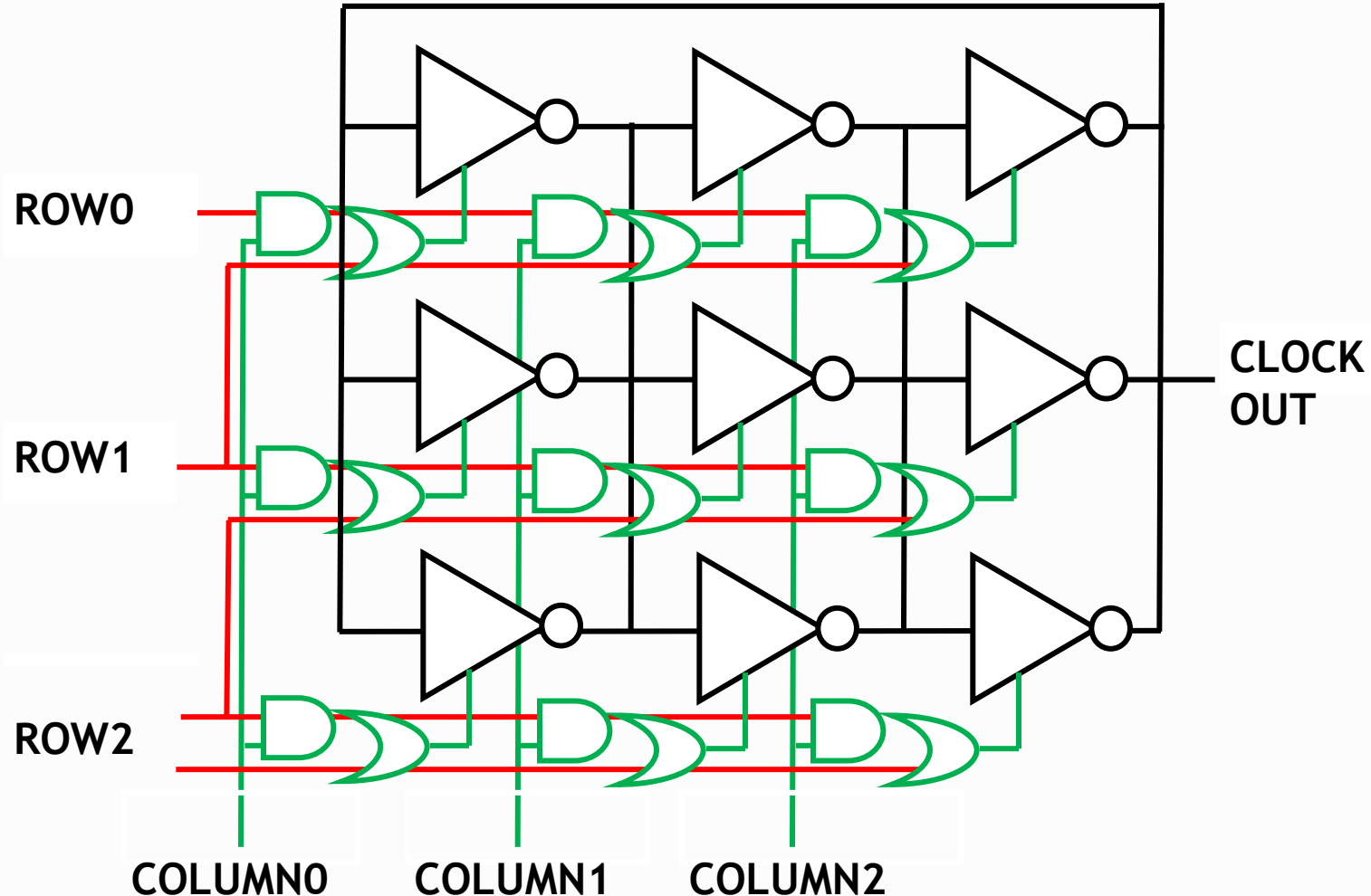


Digital output response to analog input voltage
(thermometer code)

Respond

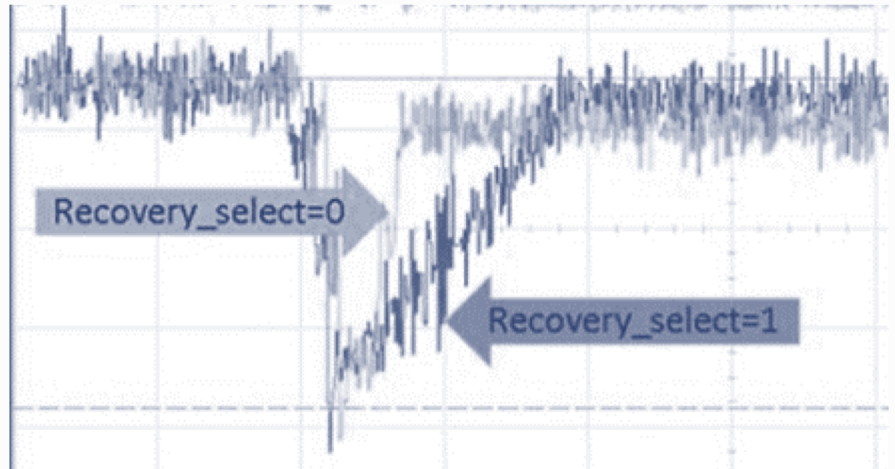
- DPLL immediate frequency reduction
 - “jump” almost instantly to protect timing margin
 - cleanly without extra clock jitter or noise
- Key = Core frequency is not locked to chip
 - digital PLL = adjustment per Quad group of cores
 - frequency of each Quad is asynchronous to rest of the POWER9 processor chip

Digitally controlled Oscillator (DCO)



- Constantly calculate number of active devices to remove in response to droop events

Droop Recovery Technique



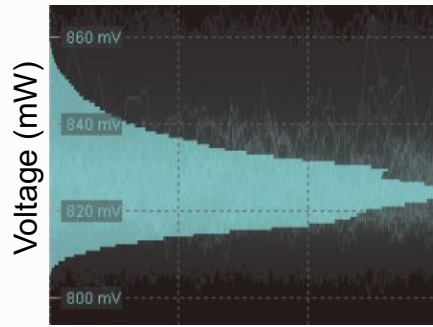
1. Recover DCO setting

- either gradually or instantly (modeable)
- to prevent frequency overshoot, fewer devices are added back initially

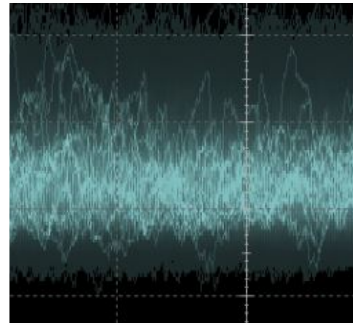
2. Restore nominal frequency filter multiplier

- normal DPLL dynamics complete the restoration
- naturally slews and locks to the original target

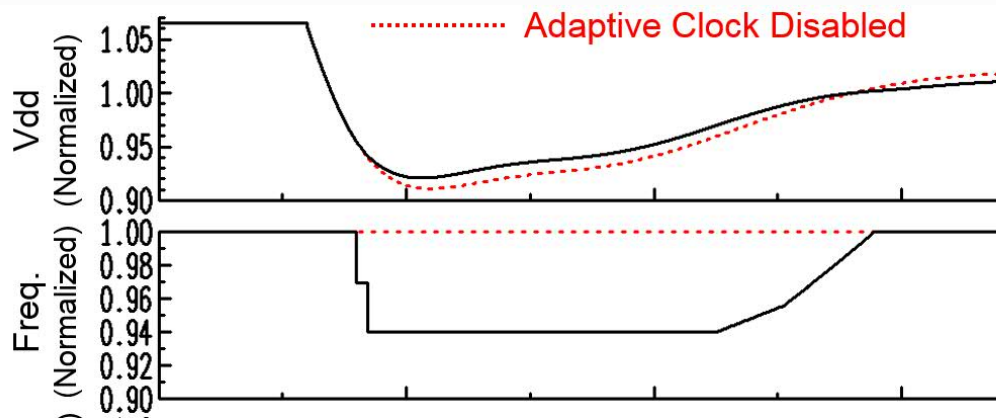
Adaptive Clocking



Voltage Histogram



V_{dd} Noise



- Provides 50% noise margin reduction
- Reduces power up to 8%

